



# BAS70J / BAS70W BAS70-04W / BAS70-05W / BAS70-06W

## SMALL SIGNAL SCHOTTKY DIODE

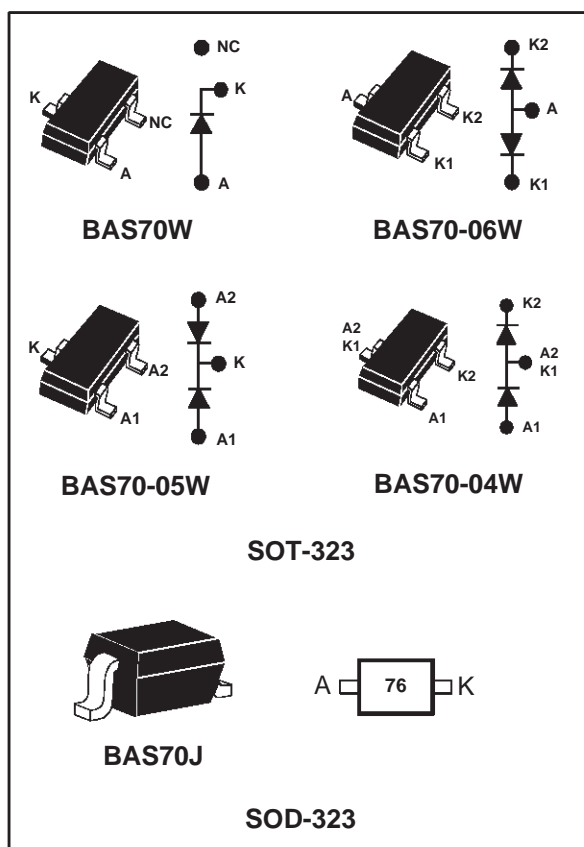
### FEATURES AND BENEFITS

- VERY SMALL CONDUCTION LOSSES
- NEGLIGIBLE SWITCHING LOSSES
- LOW FORWARD VOLTAGE DROP
- SURFACE MOUNT DEVICE

### DESCRIPTION

Schottky barrier diodes encapsulated either in SOT-323 or SOD-323 small SMD packages.

Single and double diodes with different pinning are available.



### ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage		70	V
$I_F$	Continuous forward current		70	mA
$I_{FSM}$	Surge non repetitive forward current	$t_p = 10 \text{ ms}$	1	A
$P_{tot}$	Power dissipation (note 1) $T_{amb} = 25^\circ\text{C}$	SOT-323	230	mW
		SOT-323		
$T_{stg}$	Maximum storage temperature range		- 65 to +150	$^\circ\text{C}$
$T_j$	Maximum operating junction temperature *		150	$^\circ\text{C}$
$T_L$	Maximum temperature for soldering during 10s		260	$^\circ\text{C}$

Note 1: for double diodes,  $P_{tot}$  is the total dissipation of both diodes.

\* :  $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$  thermal runaway condition for a diode on its own heatsink

**THERMAL RESISTANCE**

Symbol	Parameters		Value	Unit
R <sub>th(j-a)</sub>	Junction to ambient (*)	SOD-323	550	°C/W
		SOT-323		°C/W

(\*) Mounted on epoxy board, with recommended pad layout.

**STATIC ELECTRICAL CHARACTERISTICS (per diode)**

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
V <sub>BR</sub>	T <sub>j</sub> = 25°C	I <sub>R</sub> = 10μA	70			V
V <sub>F</sub> *	T <sub>j</sub> = 25°C	I <sub>F</sub> = 1mA			410	mV
I <sub>R</sub> **	T <sub>j</sub> = 25°C	V <sub>R</sub> = 50V			100	nA

Pulse test: \* t<sub>p</sub> = 380μs, δ < 2%

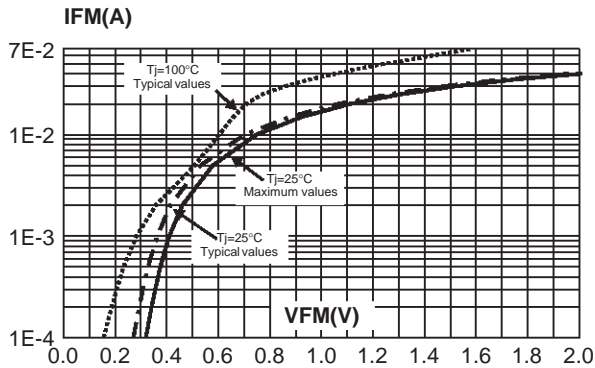
\*\* t<sub>p</sub> = 5 ms, δ < 2%

**DYNAMIC CHARACTERISTICS**

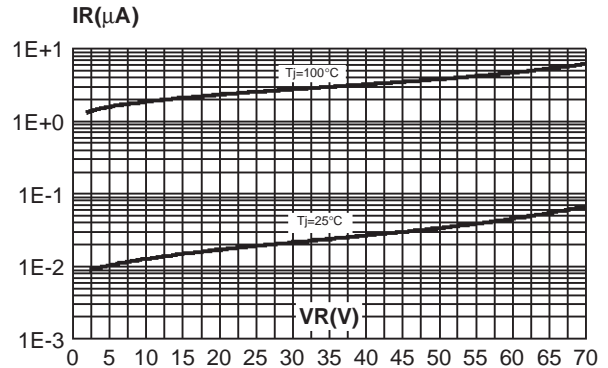
Symbol	Test Conditions		Min.	Typ.	Max.	Unit
C	T <sub>j</sub> = 25°C F = 1MHz	V <sub>R</sub> = 0V			2	pF
τ*	T <sub>j</sub> = 25°C Krakauer Method	I <sub>F</sub> = 5mA			100	ps

\* Effective carrier life time.

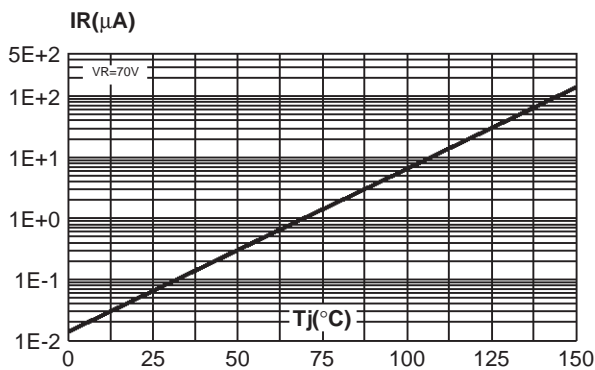
**Fig. 1:** Forward voltage drop versus forward current.



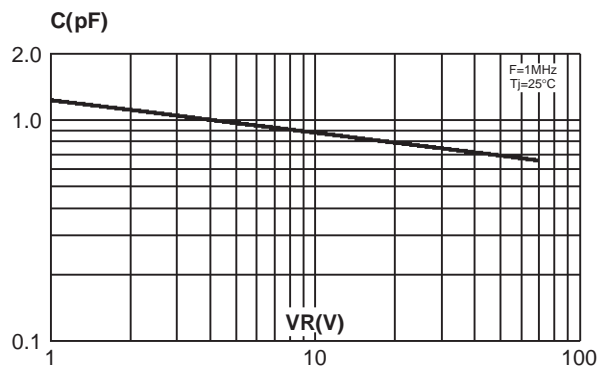
**Fig. 2:** Reverse leakage current versus reverse voltage applied (typical values).



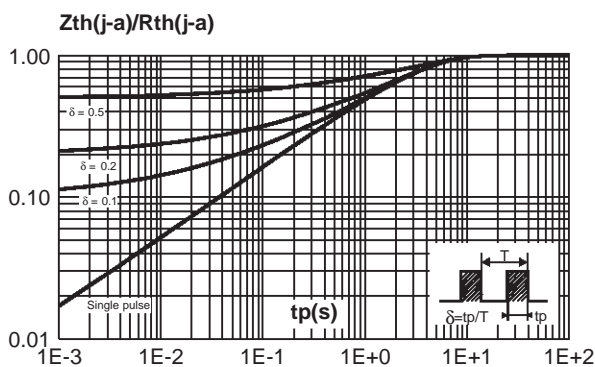
**Fig. 3:** Reverse leakage current versus junction temperature (typical values).



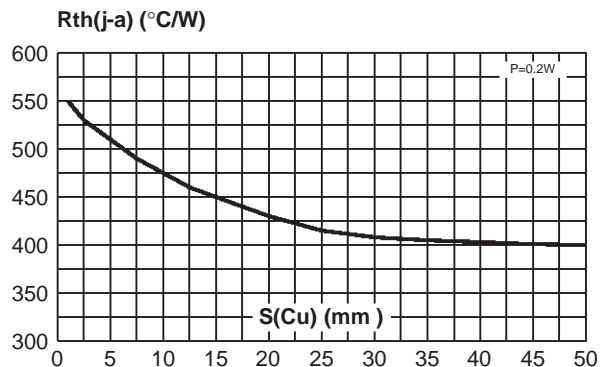
**Fig. 4:** Junction capacitance versus reverse voltage applied (typical values).



**Fig. 5:** Relative variation of thermal impedance junction to ambient versus pulse duration (epoxy FR4 with recommended pad layout, S(Cu)=35μm).

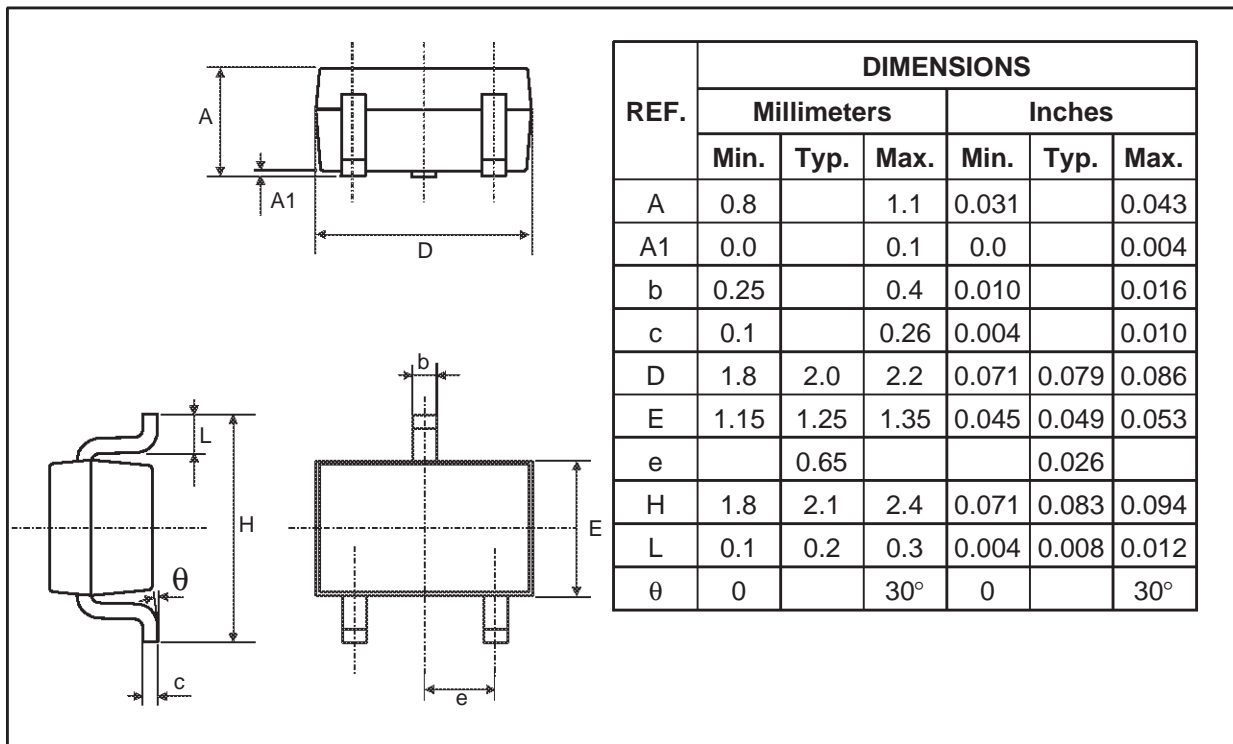


**Fig. 6:** Thermal resistance junction to ambient versus copper surface under each lead (Epoxy printed circuit board FR4, copper thickness: 35μm).

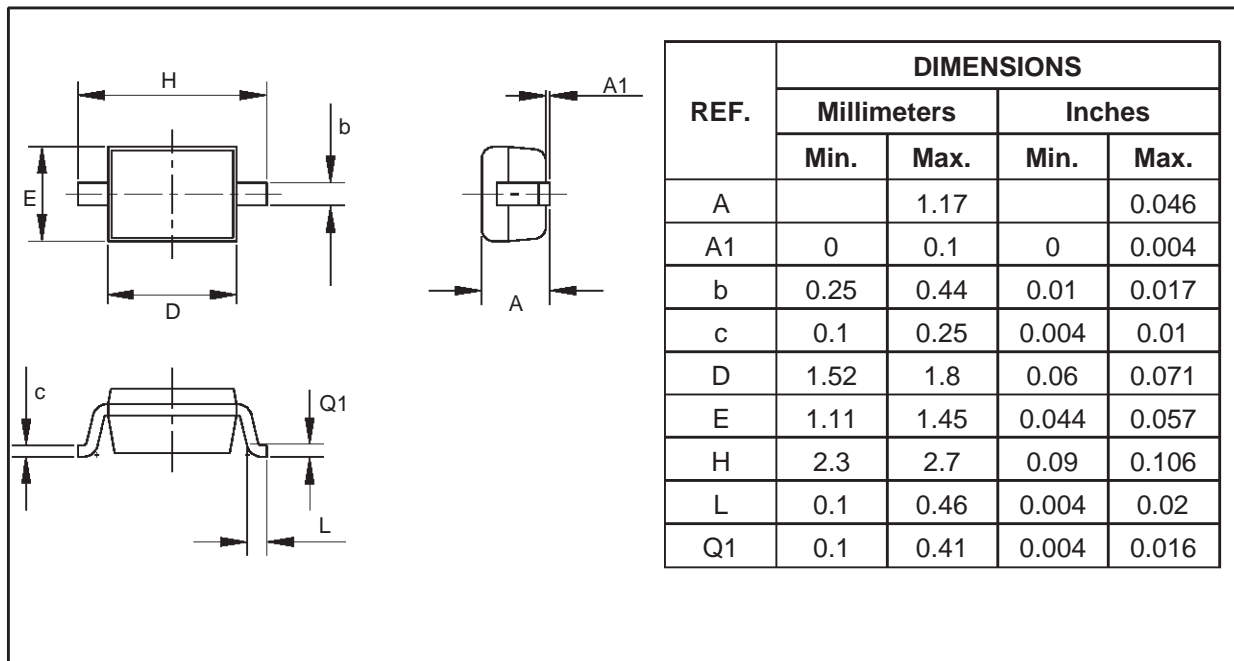


**BAS70J / BAS70W / BAS70-04W / BAS70-05W / BAS70-06W**

**PACKAGE MECHANICAL DATA**  
SOT-323



**PACKAGE MECHANICAL DATA**  
SOD-323



Ordering type	Marking	Package	Weight	Base qty	Delivery mode
BAS70W	D28	SOT-323	0.006g	3000	Tape & reel
BAS70-04W	D31	SOT-323	0.006g	3000	Tape & reel
BAS70-05W	D30	SOT-323	0.006g	3000	Tape & reel
BAS70-06W	D29	SOT-323	0.006g	3000	Tape & reel
BAS70J	76	SOD-323	0.005g	3000	Tape & reel

• Epoxy meets UL94,V0

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